L Number	Hits	Search Text	T-2
1 · ·	49		DB
	ן דד. 	stiffener and (tab adj tape)	USPAT
2	1	stiffener and (tab adj tape) and void	USPAT
3	55	stiffener and (tab adj tape)	US-PGPUB;
			EPO; JPO
4	. 0	stiffener and (tap adj tape) and semiconductor	US-PGPUB;
			EPO; JPO;
(DERWENT;
5	4 E	atifferen and their the second	IBM_TDB
J .	65	stiffener and (tab adj tape) and semiconductor	US-PGPUB;
		* * 1	EPO; JPO;
	,		DERWENT;
6	797	(257/698).CCLS.	IBM_TDB
		(60/70/0).000.	USPAT
7	803	(257/700). <i>CC</i> LS.	USPAT
	* *		
8	1610	(257/758). <i>CC</i> LS.	USPAT
9 : .	330	(257/782).CCLS.	USPAT
,			301711
10	595	(257/783).CCLS.	USPAT
: ,			10
11	1111	(257/701).CCLS.	USPAT;
)		US-PGPUB;
. 12	420	(257 /700) 651 6	EPO; JPO
12	430	(257/702). <i>CC</i> LS.	USPAT;
			US-PGPUB;
13	662	(257/703).CCLS.	EPO; JPO
1.5	002	(23///03).0023.	USPAT;
			US-PGPUB;
14	401	(257/698).CCLS.	EPO; JPO US-PGPUB;
'	101	(20,7070).0020.	EPO; JPO
15	617	(257/700). <i>CC</i> LS.	US-PGPUB;
-			EPO; JPO;
		,	DERWENT
16	1086	(257/758).CCLS.	US-PGPUB;
			EPO; JPO
17	266	(257/783). <i>CC</i> LS.	US-PGPUB;
	*		EPO; JPO
-	0	stiffener and (tap adj tape) and semiconductor	USPAT
÷	41	stiffener and (tab adj tape) and semiconductor	USPAT